

E Series Power MOSFET

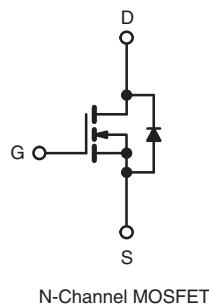
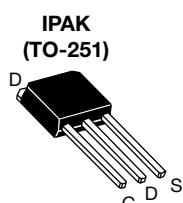
PRODUCT SUMMARY	
V _{DS} (V) at T _J max.	650
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.6
Q _g max. (nC)	40
Q _{gs} (nC)	5
Q _{gd} (nC)	9
Configuration	Single

FEATURES

- Low figure-of-merit (FOM) R_{on} x Q_g
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE



APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION

Package	IPAK (TO-251)
Lead (Pb)-free and Halogen-free	SiHU7N60E-GE3

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	600	V
T _C = -25 °C, I _D = 250 μA		575	
Gate-Source Voltage	V _{GS}	± 30	
Continuous Drain Current (T _J = 150 °C)		7	
	I _D	5	A
V _{GS} at 10 V		18	
Pulsed Drain Current ^a	I _{DM}	0.63	W/°C
Linear Derating Factor		43	mJ
Single Pulse Avalanche Energy ^b	E _{AS}	78	W
Maximum Power Dissipation	P _D	-55 to +150	°C
Operating Junction and Storage Temperature Range	T _J , T _{stg}		
Drain-Source Voltage Slope	dV/dt	70	V/ns
Reverse Diode dV/dt ^d		3	
Soldering Recommendations (Peak Temperature) ^c	for 10 s	300	°C

Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- V_{DD} = 50 V, starting T_J = 25 °C, L = 13.8 mH, R_g = 25 Ω, I_{AS} = 2.5 A.
- 1.6 mm from case.
- I_{SD} ≤ I_D, dI/dt = 100 A/μs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS

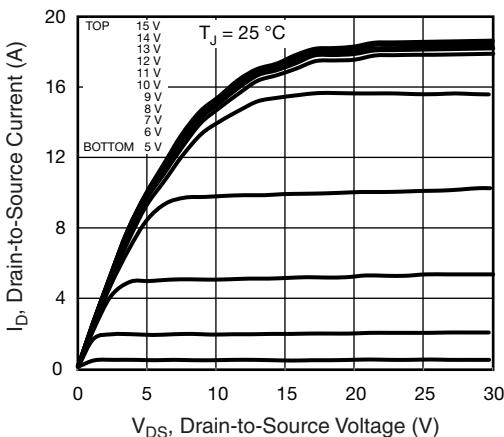
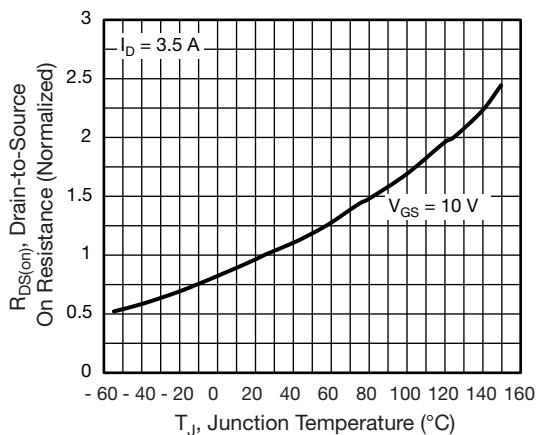
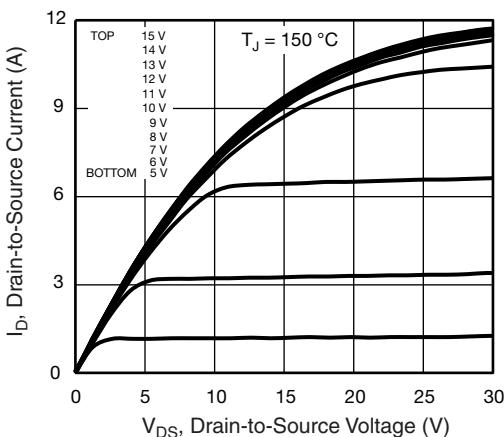
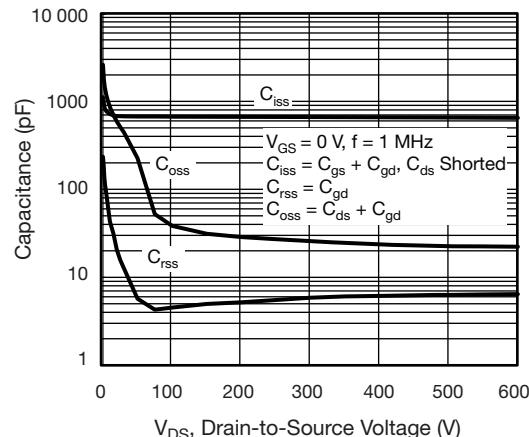
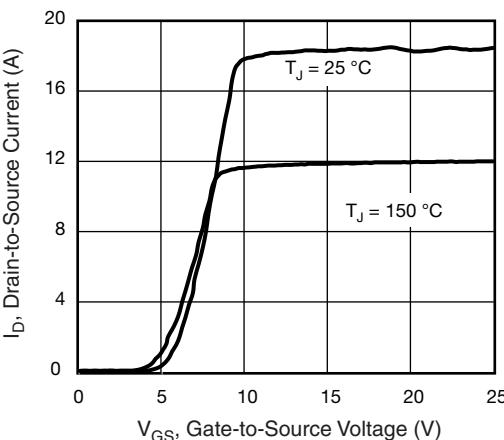
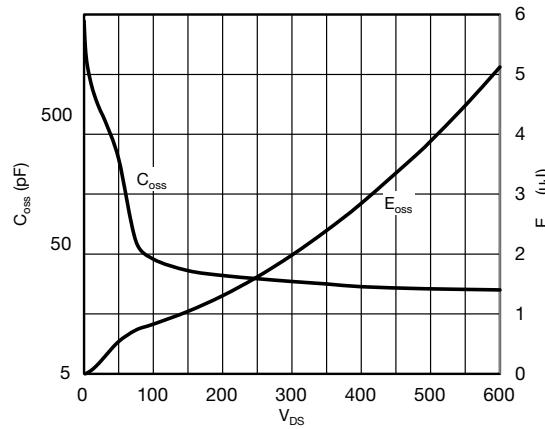
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	62	$^{\circ}\text{C}/\text{W}$
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.6	

SPECIFICATIONS ($T_J = 25 \text{ }^{\circ}\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}$, $I_D = 250 \mu\text{A}$		609	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25 \text{ }^{\circ}\text{C}$, $I_D = 1 \text{ mA}$		-	0.68	-	$\text{V}/^{\circ}\text{C}$
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$		2	-	4	V
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
		$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 600 \text{ V}$, $V_{GS} = 0 \text{ V}$		-	-	1	μA
		$V_{DS} = 480 \text{ V}$, $V_{GS} = 0 \text{ V}$, $T_J = 125 \text{ }^{\circ}\text{C}$		-	-	10	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$	$I_D = 3.5 \text{ A}$	-	0.5	0.6	Ω
Forward Transconductance	g_{fs}	$V_{DS} = 50 \text{ V}$, $I_D = 3.5 \text{ A}$		-	1.9	-	S
Dynamic							
Input Capacitance	C_{iss}	$V_{GS} = 0 \text{ V}$, $V_{DS} = 100 \text{ V}$, $f = 1 \text{ MHz}$		-	680	-	pF
Output Capacitance	C_{oss}			-	39	-	
Reverse Transfer Capacitance	C_{rss}			-	5	-	
Effective Output Capacitance, Energy Related ^a	$C_{o(er)}$	$V_{DS} = 0 \text{ V to } 480 \text{ V}$, $V_{GS} = 0 \text{ V}$		-	34	-	
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$			-	100	-	
Total Gate Charge	Q_g			-	20	40	nC
Gate-Source Charge	Q_{gs}	$V_{GS} = 10 \text{ V}$	$I_D = 3.5 \text{ A}$, $V_{DS} = 480 \text{ V}$	-	5	-	
Gate-Drain Charge	Q_{gd}			-	9	-	
Turn-On Delay Time	$t_{d(on)}$			-	13	26	ns
Rise Time	t_r	$V_{DD} = 480 \text{ V}$, $I_D = 3.5 \text{ A}$, $V_{GS} = 10 \text{ V}$, $R_g = 9.1 \Omega$		-	13	26	
Turn-Off Delay Time	$t_{d(off)}$		-	24	48		
Fall Time	t_f		-	14	28		
Gate Input Resistance	R_g	$f = 1 \text{ MHz}$, open drain		-	1.1	-	Ω
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	A
Pulsed Diode Forward Current	I_{SM}			-	-	18	
Diode Forward Voltage	V_{SD}	$T_J = 25 \text{ }^{\circ}\text{C}$, $I_S = 3.5 \text{ A}$, $V_{GS} = 0 \text{ V}$		-	-	1.2	V
Reverse Recovery Time	t_{rr}	$T_J = 25 \text{ }^{\circ}\text{C}$, $I_F = I_S = 3.5 \text{ A}$, $dI/dt = 100 \text{ A}/\mu\text{s}$, $V_R = 20 \text{ V}$		-	230	-	ns
Reverse Recovery Charge	Q_{rr}			-	1.9	-	μC
Reverse Recovery Current	I_{RRM}			-	14	-	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

Fig. 2 - Typical Output Characteristics

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 3 - Typical Transfer Characteristics

Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

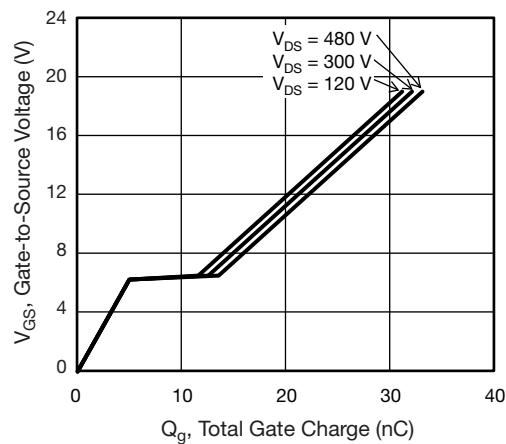


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

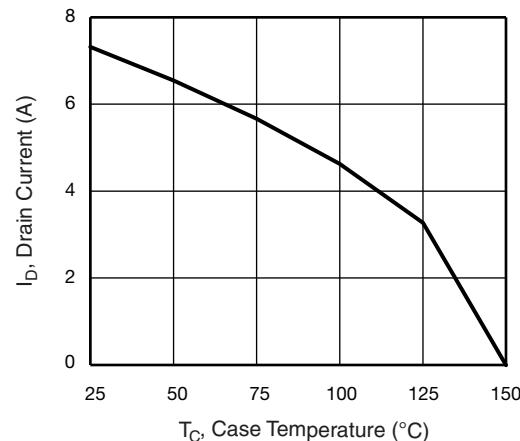


Fig. 10 - Maximum Drain Current vs. Case Temperature

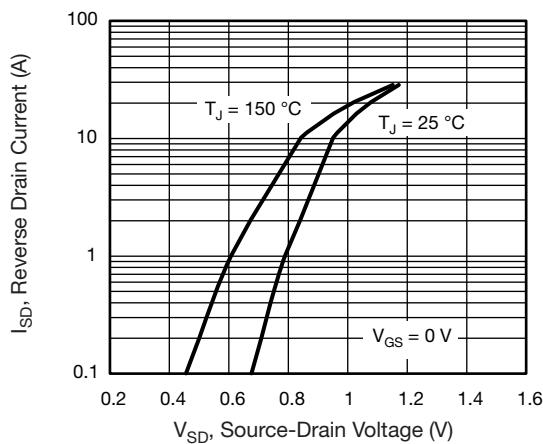


Fig. 8 - Typical Source-Drain Diode Forward Voltage

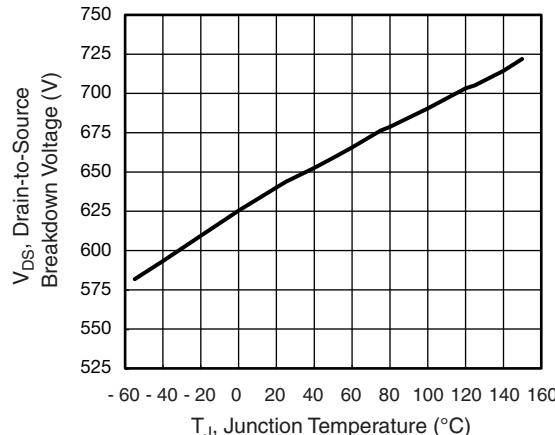


Fig. 11 - Temperature vs. Drain-to-Source Voltage

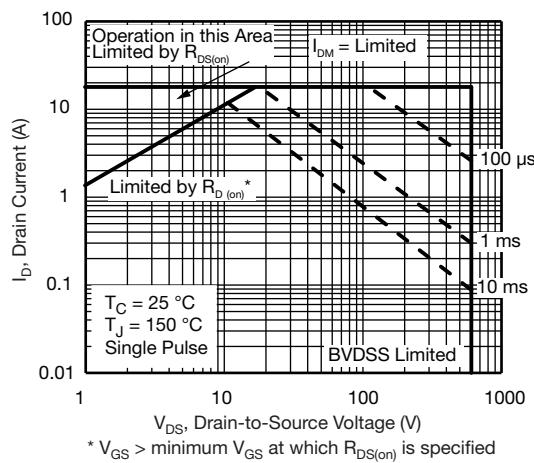


Fig. 9 - Maximum Safe Operating Area

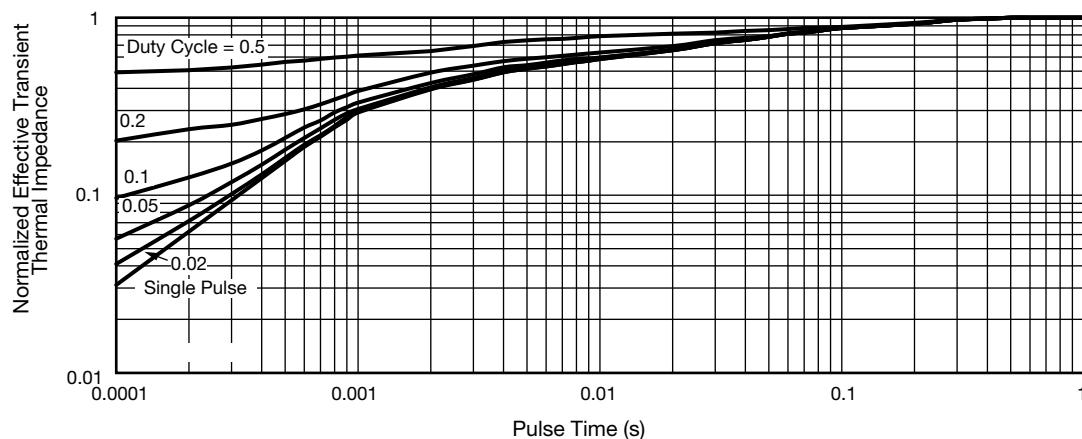


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

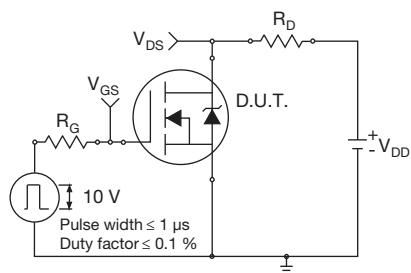


Fig. 13 - Switching Time Test Circuit

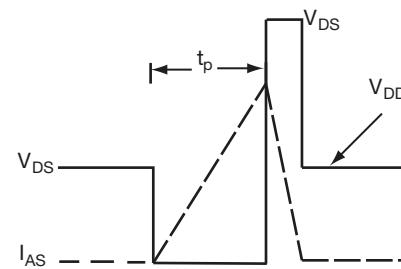


Fig. 16 - Unclamped Inductive Waveforms

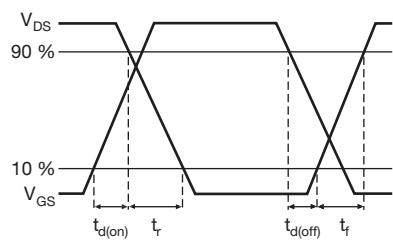


Fig. 14 - Switching Time Waveforms

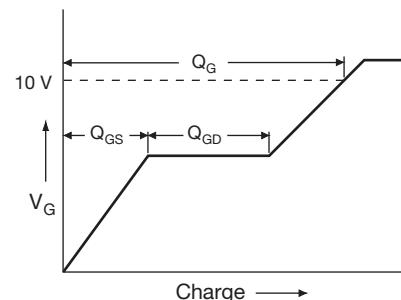


Fig. 17 - Basic Gate Charge Waveform

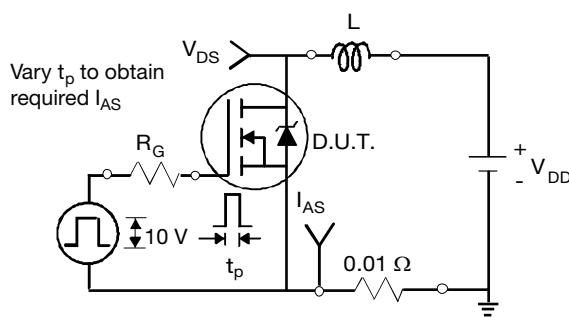


Fig. 15 - Unclamped Inductive Test Circuit

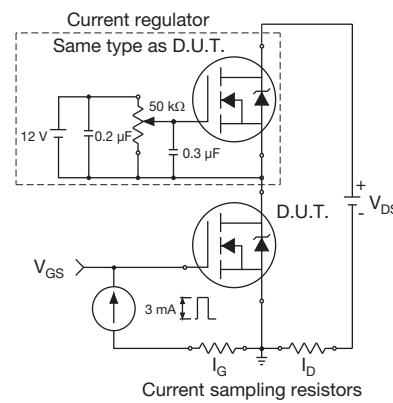


Fig. 18 - Gate Charge Test Circuit

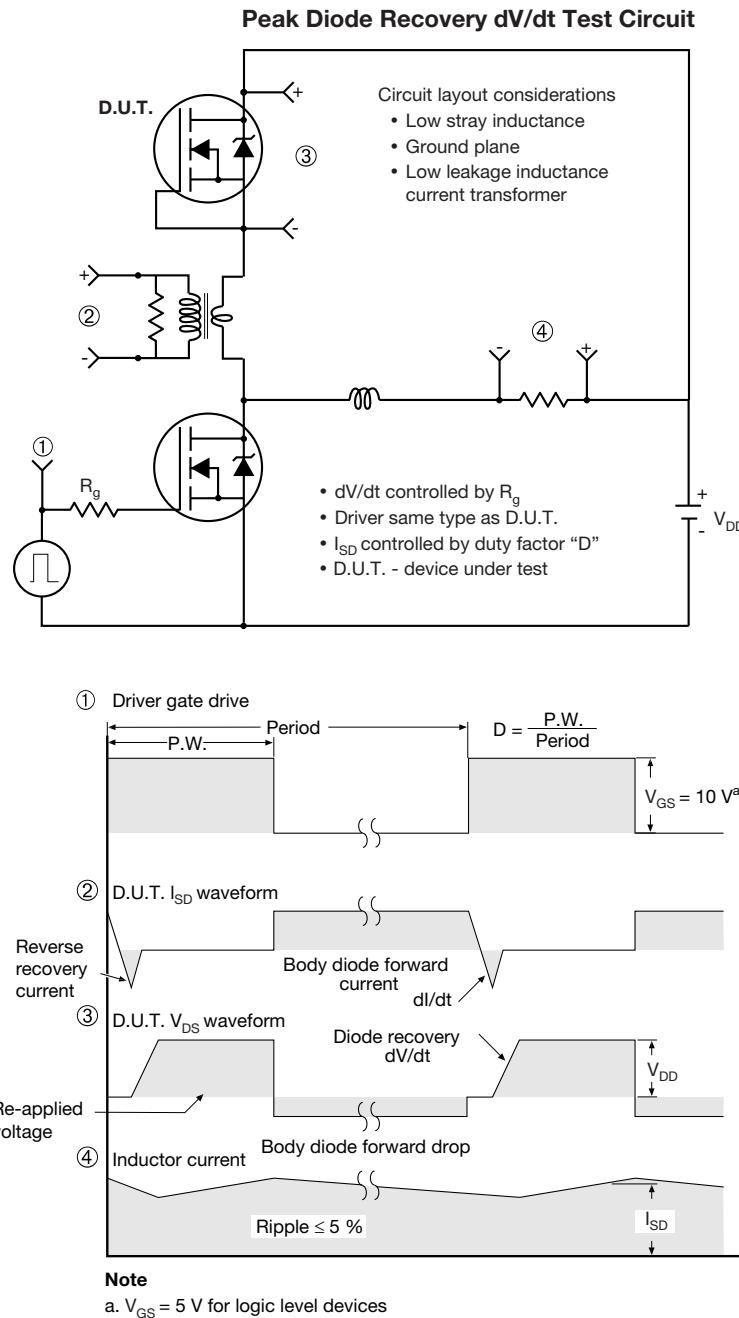
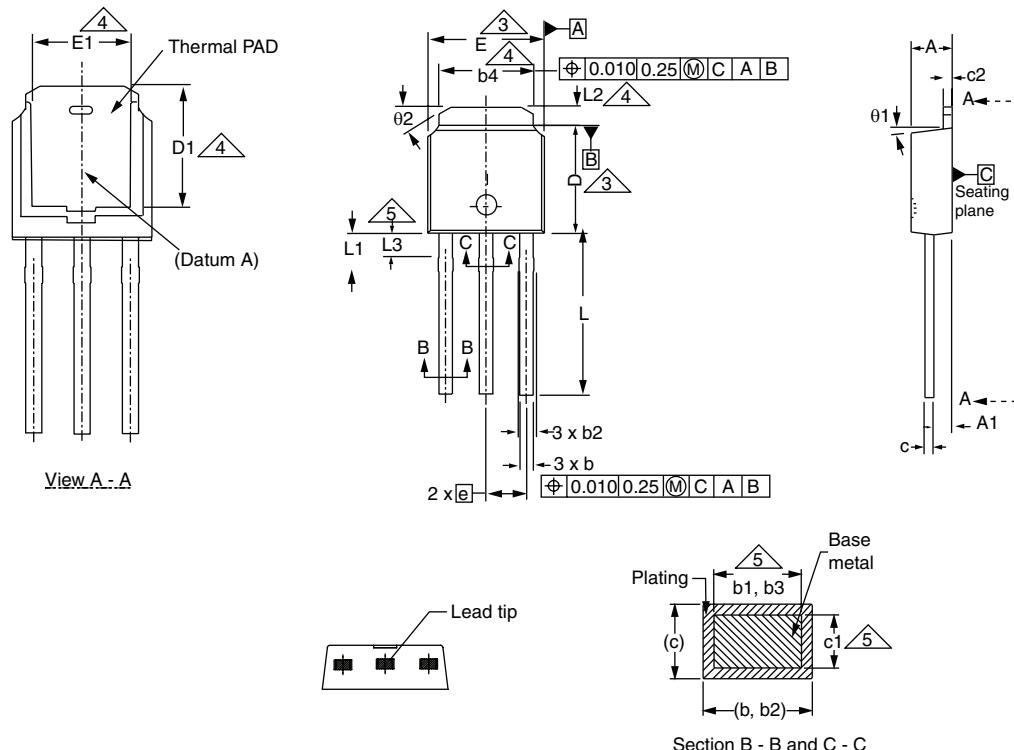


Fig. 19 - For N-Channel

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TO-251AA (HIGH VOLTAGE)



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

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DWG: 5968

	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
e	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
01	0'	15'	0'	15'
02	25'	35'	25'	35'

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994.
- Dimension are shown in inches and millimeters.
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- Lead dimension uncontrolled in L3.
- Dimension b1, b3 and c1 apply to base metal only.
- Outline conforms to JEDEC outline TO-251AA.



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